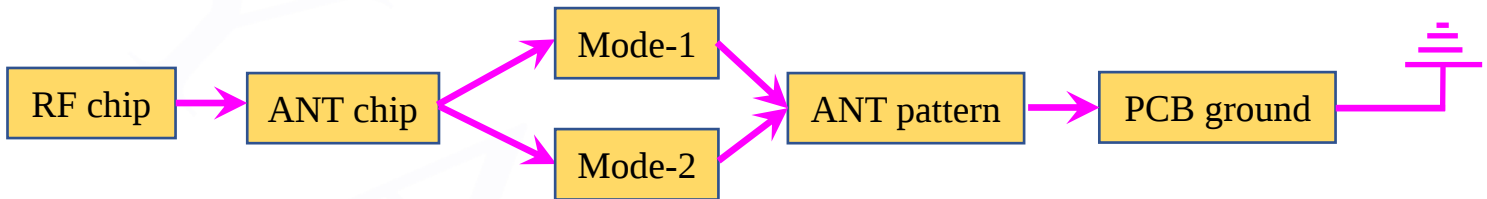




P/N: HY160808 SRF12A

✓ Features:

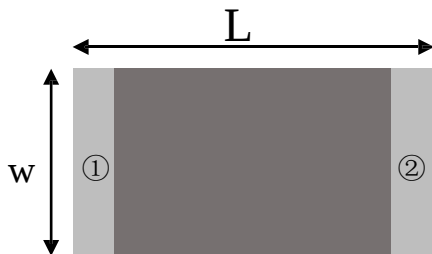
1. Surface mounted element with a small dimension of $1.6 \times 0.8 \times 0.8$ mm meet future miniaturization trend.
2. Embedded and LTCC (low temperature co-fired ceramic) technology is able to integrate with system design as well as beautifying the housing of final product.
3. Miniaturization, wideband, high stability, low ESR, and low tolerance.
4. Dual-band resonances in the dominant and harmonic modes enables multiband operations.
5. Novel ground-radiation technique enables radiation from both the antenna and the ground plane.



✓ Applications:

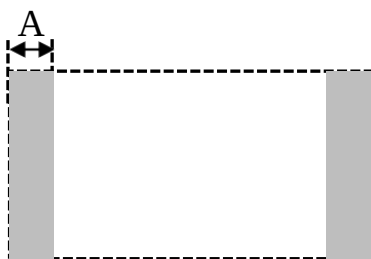
1. Bluetooth
2. Dual-band WLAN
3. ISM and UWB

✓ Dimensions (Unit: mm)



(Top View)

Number	Terminal Name
①	INPUT
②	NC



(Bottom View)



(Side View)

Symbols	L	W	T	A
Dimensions	1.60 ± 0.20	0.80 ± 0.20	0.80 ± 0.20	0.30 ± 0.10

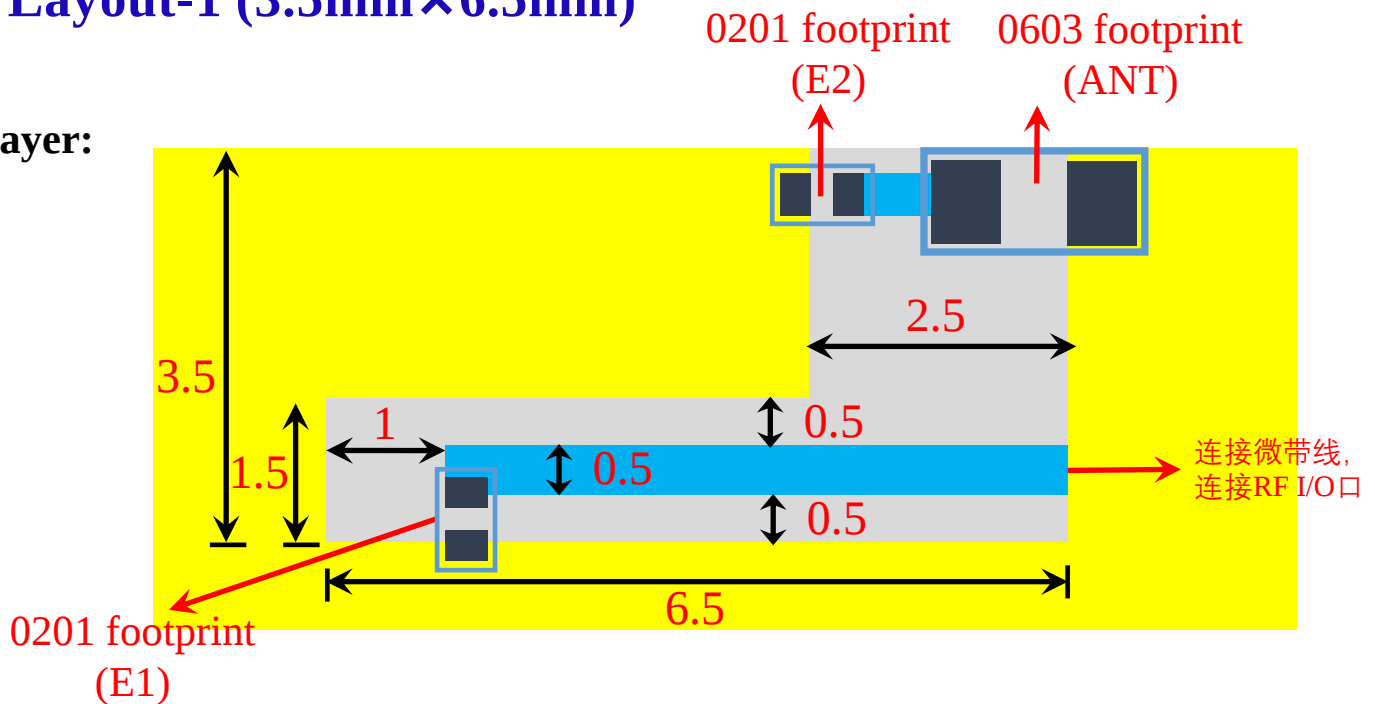
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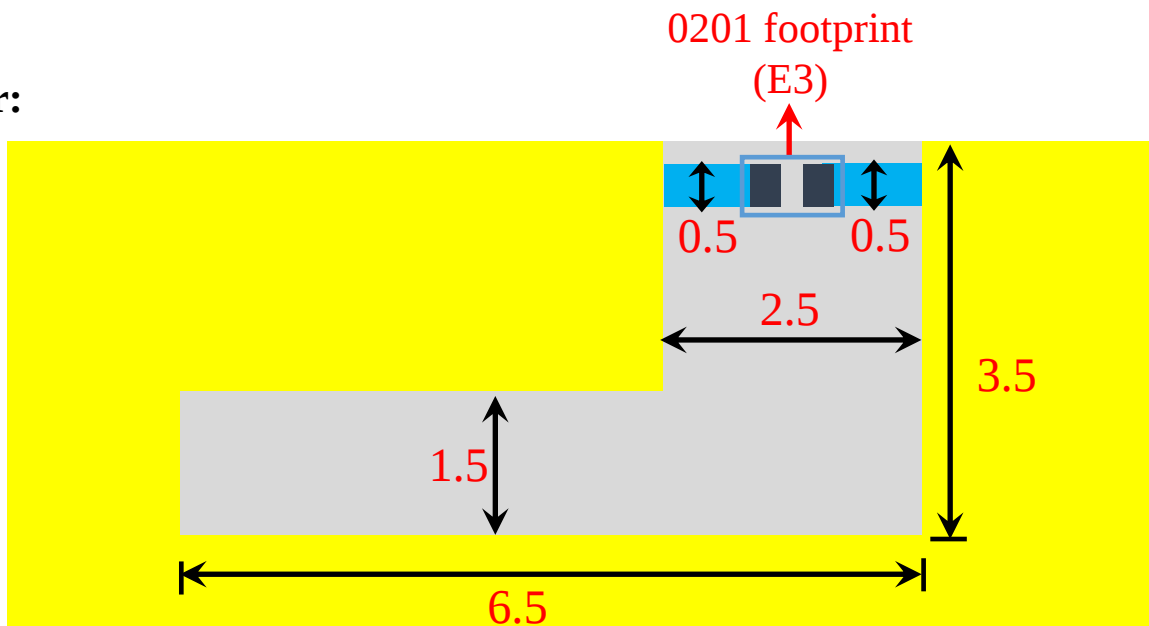
P/N: HY160808 SRF12A

✓ Layout-1 (3.5mm×6.5mm)

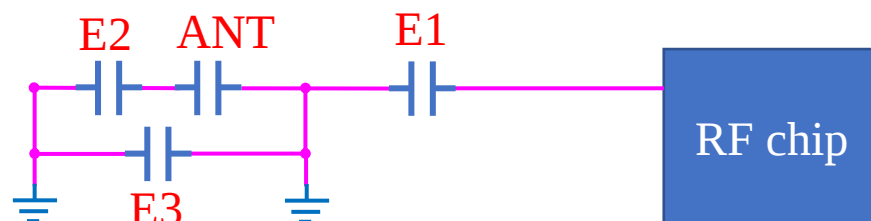
Top layer:



Bottom layer:



Equivalent circuit:

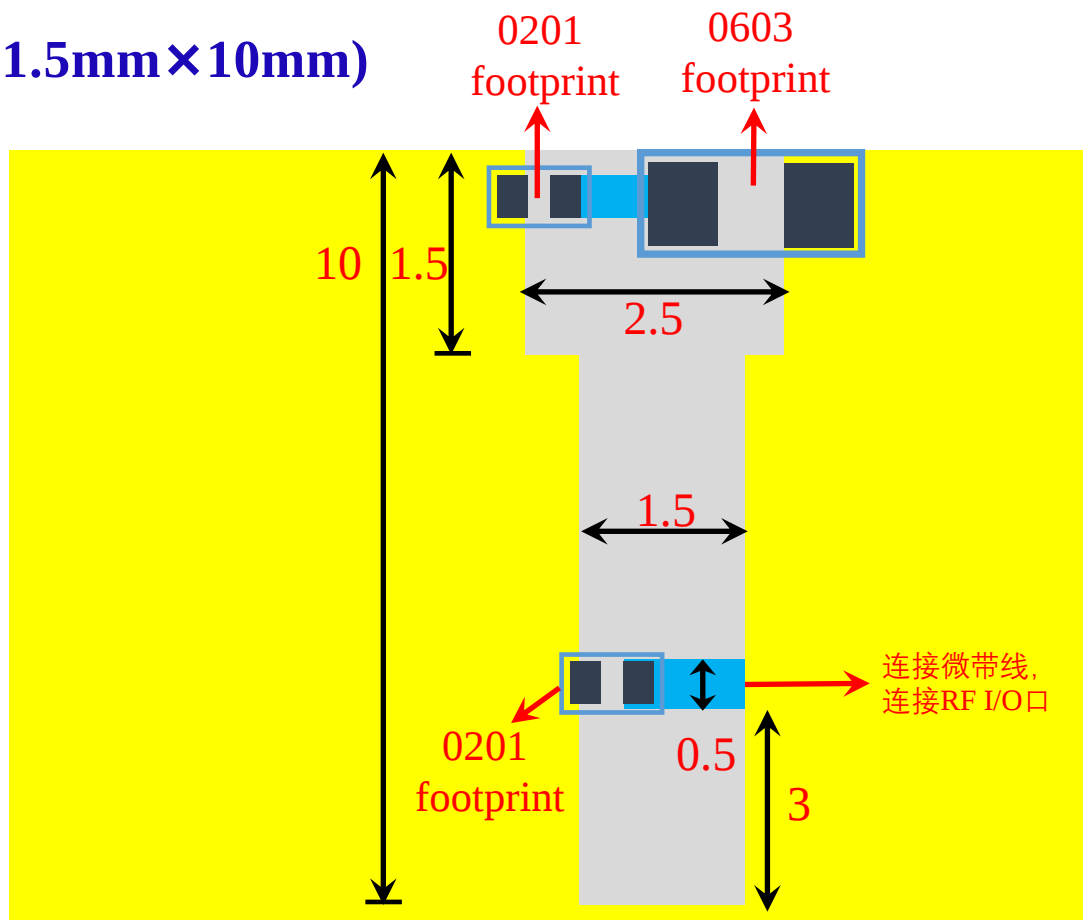




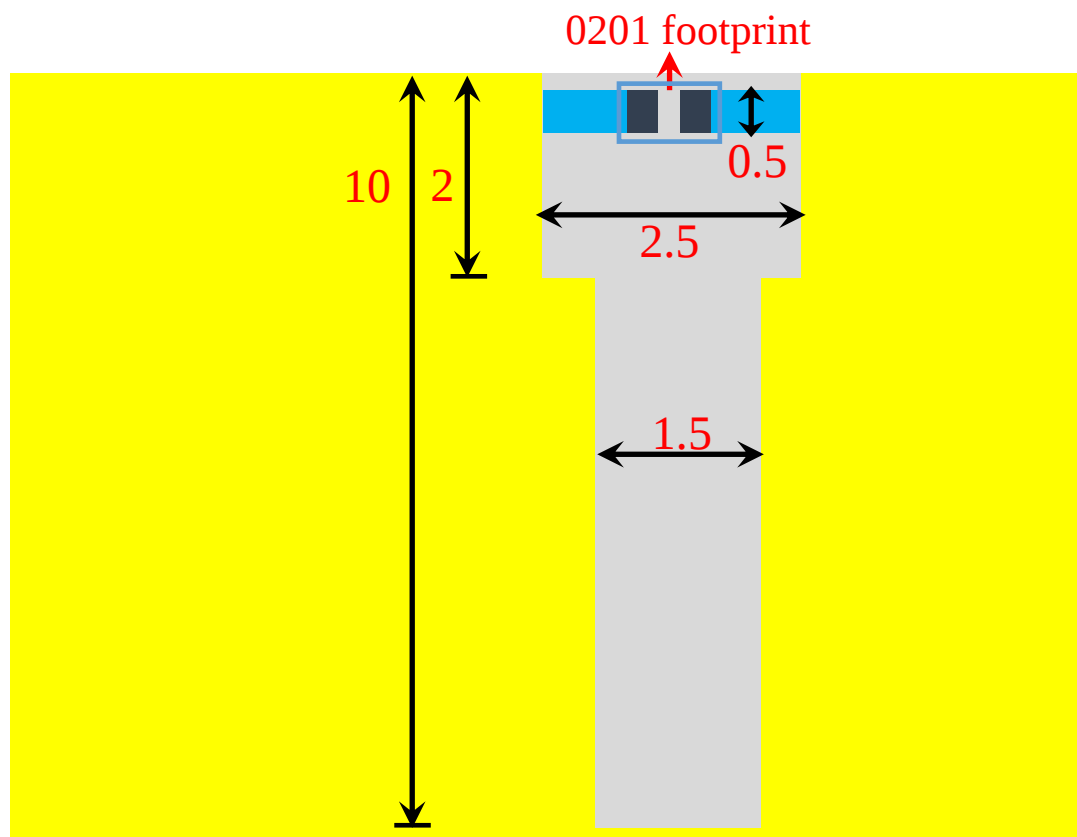
P/N: HY160808 SRF12A

✓ Layout-2 (1.5mm×10mm)

Top layer:



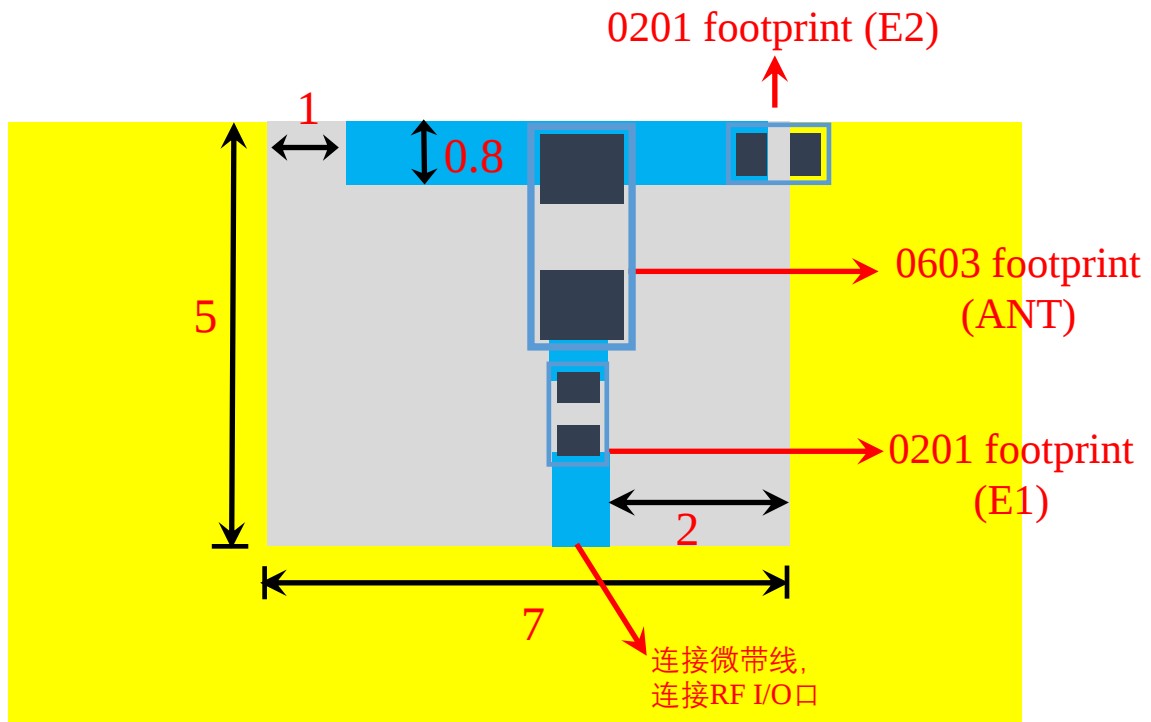
Bottom layer:



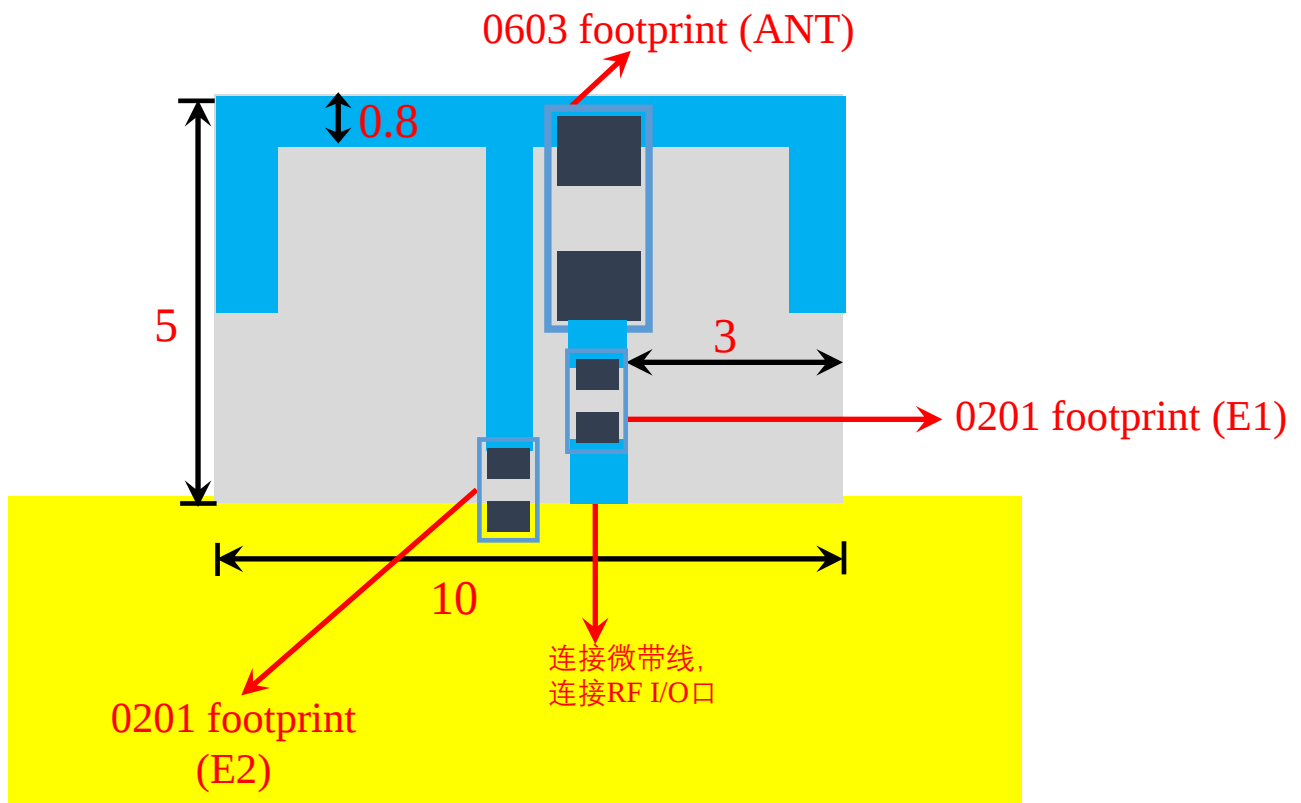


P/N: HY160808 SRF12A

✓ Layout-3 (5mm×7mm)



✓ Layout-4 (5mm×10mm)



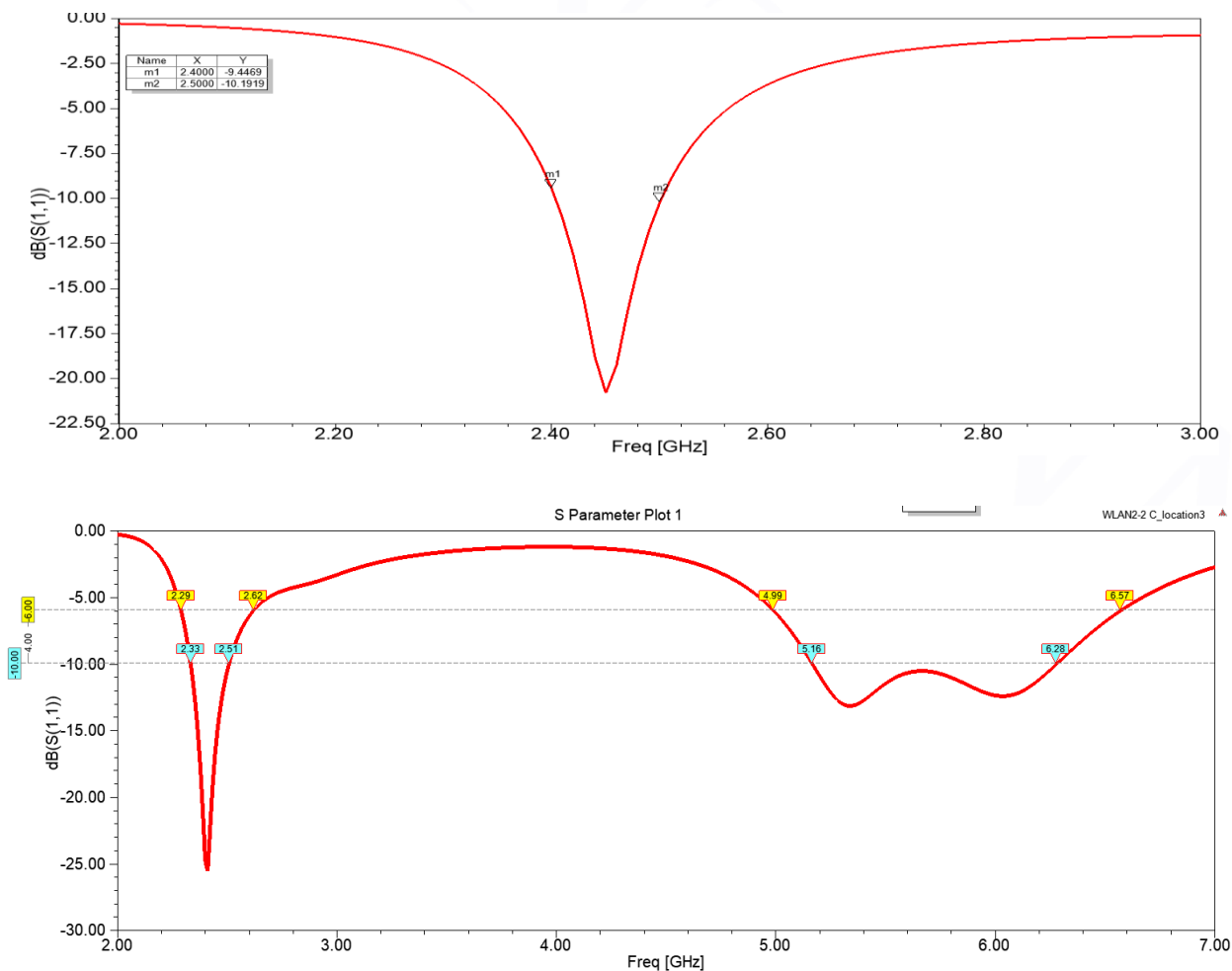


P/N: HY160808 SRF12A

✓ Electrical Characteristics:

	Feature	Specification
1	Central frequency	2.45GHz&5.5GHz
2	Bandwidth	>150MHz
3	Peak gain	>2.8dBi
4	VSWR	<2
5	Polarization	Linear
6	Azimuth beamwidth	Omnidirectional
7	Impedance	50 Ω

✓ Characteristic Curves:

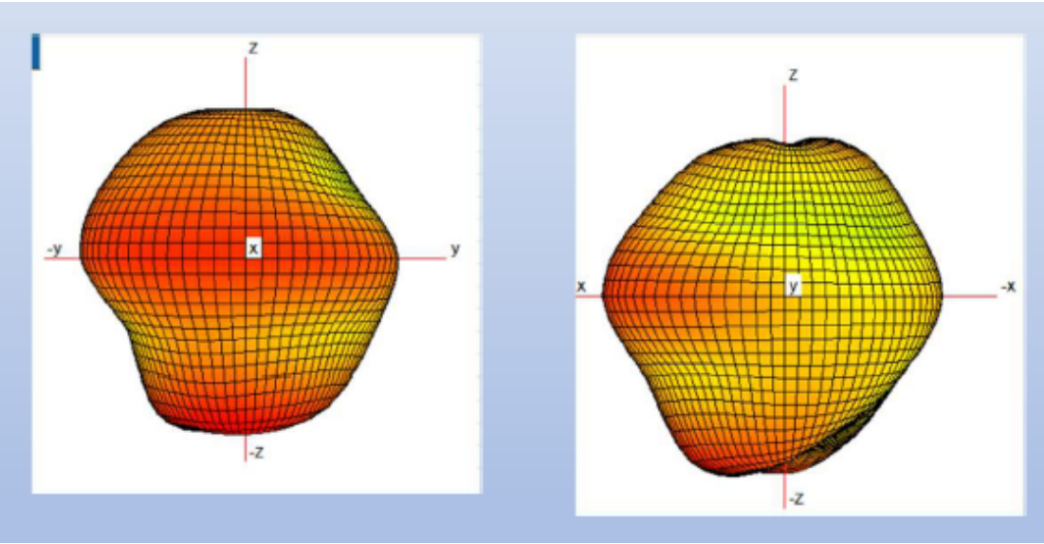
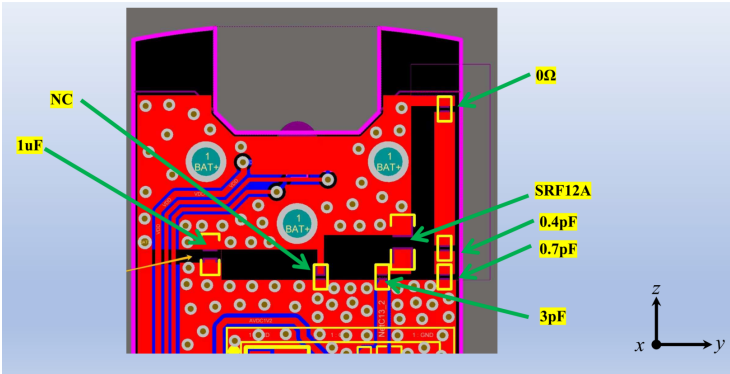


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P/N: HY160808 SRF12A

✓ Radiation Pattern:



✓ Radiation Performance:

Frequency (MHz)	Max Gain (dBi)
2400	1.8
2450	2.8
2500	1.2

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P/N: HY160808 SRF12A

✓ Dependability Test

Test Temperature	25°C ± 5°C
Operating Temperature	-25°C ~ +125°C
Temperature	5~40°C
Relative Humidity	20~70%

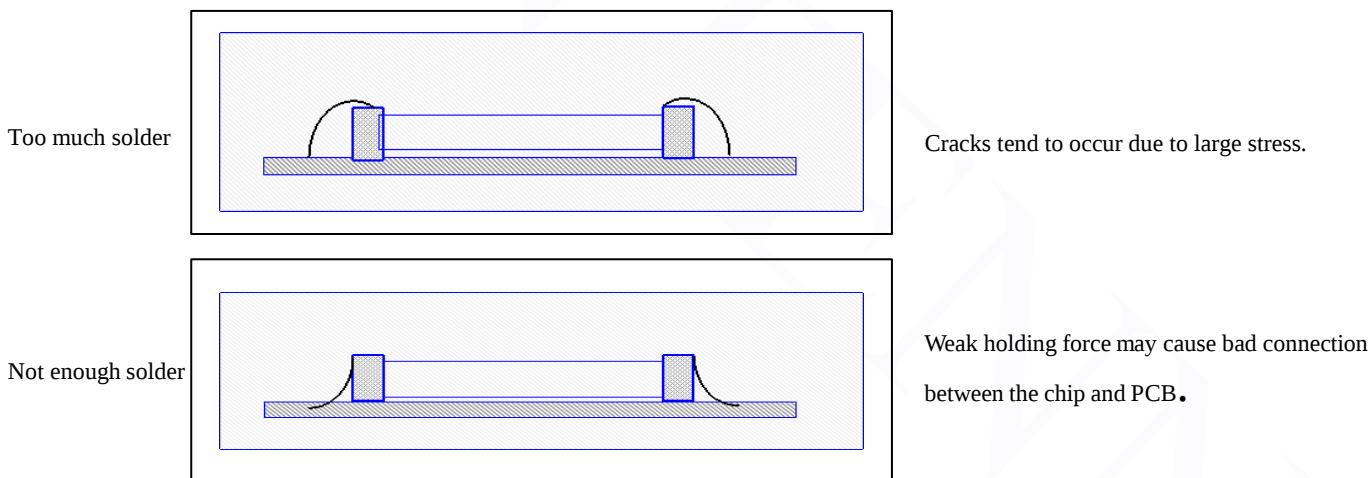
✓ Moisture Proof

Temperature: 40 ± 2°C Humidity: 90~95%RH
Duration: 500h
Recovery conditions: Room temperature Recovery Time: 24h (Class1) or 48h (Class2)

✓ Solderability

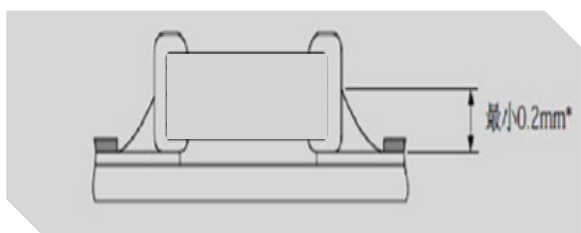
At least 95% of the terminal electrode is covered by new solder.
Preheating conditions: 80 to 120°C; 10~30s.
Solder Temperature: 235 ± 5°C Duration: 2 ± 0.5s, Solder Temperature: 245 ± 5°C Duration: 2 ± 0.5s

✓ Optimum Solder Amount for Reflow Soldering

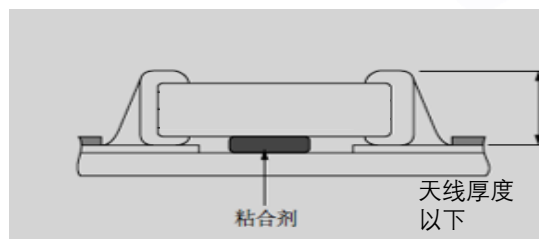


✓ Recommended Soldering Amounts

The optimal solder fillet amounts for re-flow soldering



The optimal solder fillet amounts for wave soldering





P/N: HY160808 SRF12A

✓ **Temperature Cycle Test**

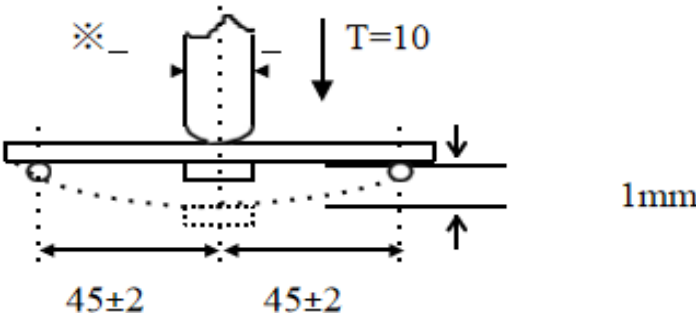
10±1S Applied Force: 5N Duration: 10±1S
Preheating conditions: up-category temperature, 1h
Recovery time: 24±1h
Initial Measurement
Cycling Times: 5 times, 1 cycle, 4 steps:

阶段	温度 (℃)	时间 (分钟)
第 1 步	下限温度(NPO/X7R/X7S/X6S/X5R: -55 Y5V: -25 Z5U: +10)	30
第 2 步	常温 (+20)	2~3
第 3 步	上限温度(NPO/X7R/X7S: +125 Y5V/Z5U/X5R: +85 X6S: +105)	30
第 4 步	常温 (+20)	2~3

✓ **Resistance to Soldering Heat**

Preheating 80 to 120℃; 10~30s. Solder Temperature: 235±5℃; Duration: 2±0.5s; Solder Temperature: 245±5℃
Duration: 2±0.5s; Preheating 100 to 200℃; 10±2min.
Solder Temperature: 265±5℃; Duration: 10±1s
Clean the capacitor with solvent and examine it with a 10X(min.) microscope.
Recovery Time: 24±2h
Recovery condition: Room temperature

✓ **Resistance to Flexure of Substrate**



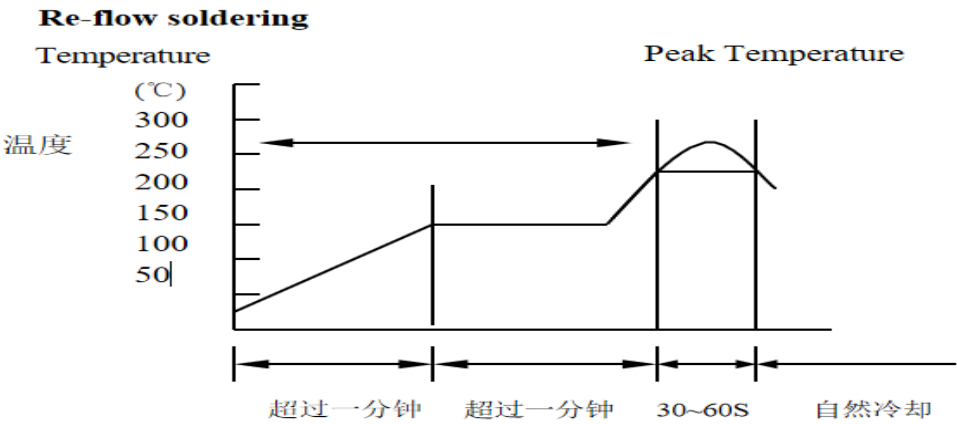
Test Board: Al₂O₃ or PCB Warp: 1mm Speed: 0.5mm/sec.
Unit: mm

The measurement should be made with the board in the bending position.



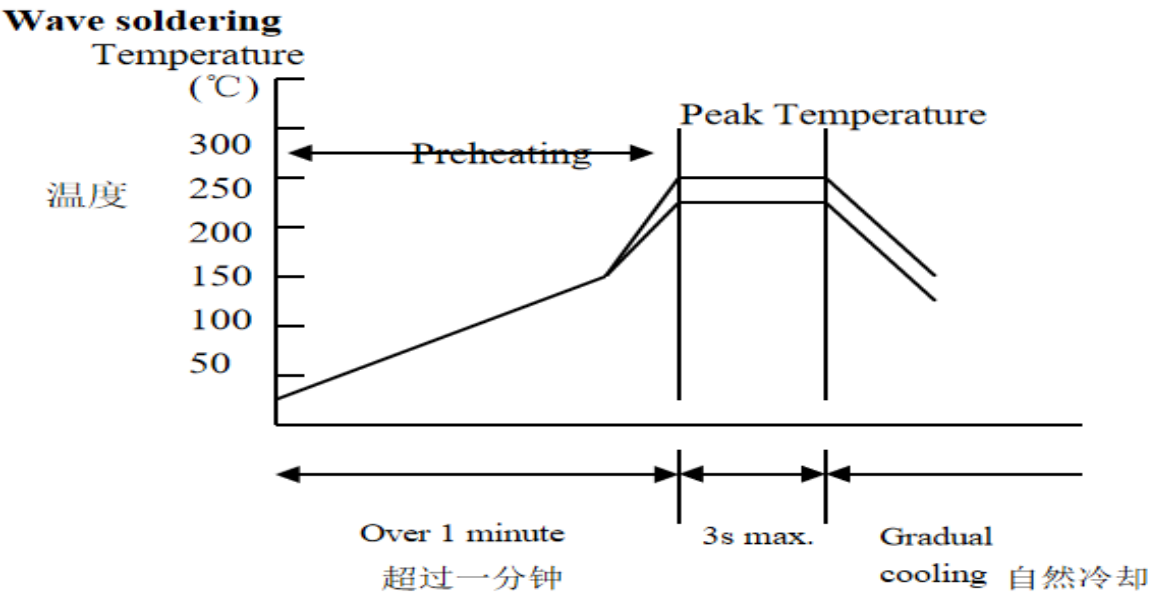
P/N: HY160808 SRF12A

The temperature profile for soldering



	Pb-Sn 焊接 Pb-Sn soldering	无铅焊接 Lead-free soldering
尖峰温度 Peak temperature	230℃~250℃	240℃~260℃

While in preheating, please keep the temperature difference between soldering temperature and surface temperature of chips as: $T \leq 150^{\circ}\text{C}$.

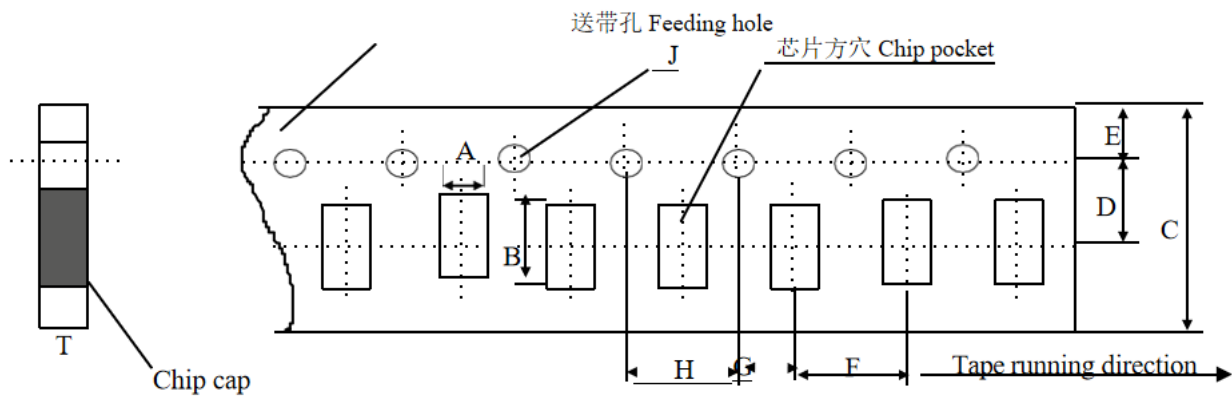


	Pb-Sn 焊接 Pb-Sn soldering	无铅焊接 Lead-free soldering
尖峰温度 Peak temperature	230℃~260℃	240℃~270℃



P/N: HY160808 SRF12A

✓ **Dimensions of paper taping**

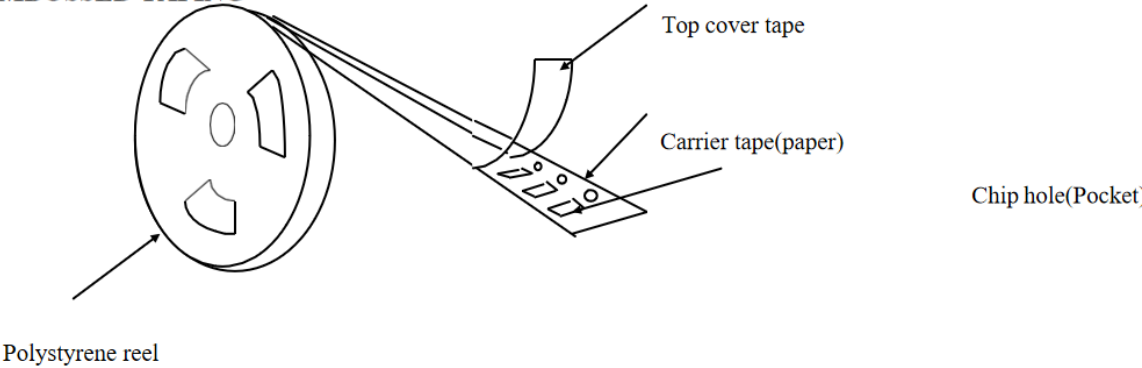


Unit: mm

代号Code 纸带规格 papersize	A	B	C	D*	E	F	G*	H	J	T
尺寸	1.10 ±0.10	1.90 ±0.10	8.00 ±0.10	3.50 ±0.05	1.75 ±0.10	4.00 ±0.10	2.00 ±0.10	4.00 ±0.10	1.50 -0/+0.10	1.10 Max

Reel (4000 pcs/Reel)

EMBOSED TAPING



✓ **Storage Period**

The guaranteed period for solderability is 6 months (Under deliver package condition).
Temperature:5~40°C /Relative Humidity:20~70%

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